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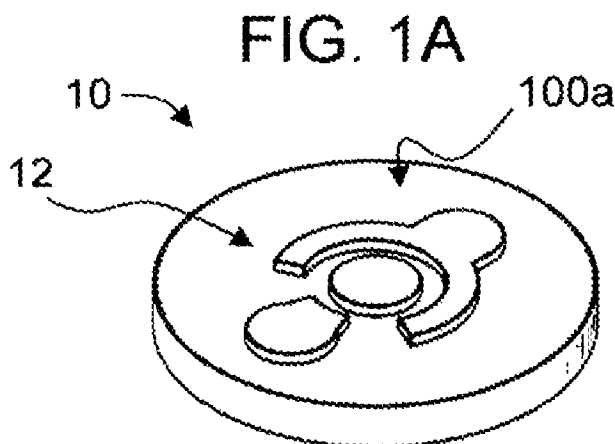
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(57) Abstract: A sensor system is disclosed. The system comprises: a solid substrate having a front side and a back side, a sensing assembly formed on the front side and being configured to provide electrochemical sensing, a plurality of electrical contacts, formed on the back side and being in electrical communication with the sensing assembly via a plurality of interconnects passing through the substrate and extending at least from the front side to the back side, and a mounting member configured for mounting the back side onto a tip of a movable device.

PLACEABLE SENSOR AND METHOD OF USING SAME

RELATED APPLICATION

This application claims the benefit of priority of U.S. Provisional Patent
5 Application No. 61/679,740 filed August 5, 2012, the contents of which are incorporated
herein by reference in their entirety.

FIELD AND BACKGROUND OF THE INVENTION

The present invention, in some embodiments thereof, relates to a sensor and,
10 more particularly, but not exclusively, to a sensor that is placeable on an organ or a
sample, and to method of using such a sensor.

It is known to measure the concentration of a target substance to be analyzed in
an aqueous liquid sample by placing the sample into a reaction zone of an
electrochemical cell comprising two electrodes having an impedance which renders
15 them suitable for amperometric measurement. The target substance is allowed to react
directly or indirectly with a redox reagent whereby to form an oxidisable (or reducible)
substance in an amount corresponding to the concentration of the target substance. The
quantity of the oxidisable (or reducible) substance present is then estimated
electrochemically.

20 Another approach involves the use of biosensors. Biosensors utilize molecular
recognition capability of biomaterial, and use the biomaterial as a molecular recognizing
element. When the biomaterial recognizes the target substance, it reacts and provides a
signal. The biosensors utilize those reactions and measure the quantity of the target
substance.

25 U.S. Patent No. 6,022,463 discloses a sensor for use in a fluid analyte analyzer.
The sensor includes a substrate, a subminiature through hole which traverses the
substrate and which is filled with a conductive material, and a sensor electrode formed
on a planar surface over the through hole. The conductive material disposed within the
through hole is compatible with the material from which the sensor electrode is made.

30 U.S. Published Application No. 20080247908 discloses a microchip which
includes a substrate, coupling circuits on a front side of the substrate, and electrical feed-
through passages. The coupling circuits perform and process a wireless physical

interaction. The feed-through passages connect a component of the coupling circuits to an externally accessible terminal which is disposed at a location remote from the front side of the substrate.

U.S. Published Application No. 20080312524 discloses a medical sensor which
5 attaches to the body of a patient. The medical sensor includes an electrode layer having conductive material formed on a dielectric film. Electrodes and conductive traces are formed on the electrode layer from the conductive material. A motion sensor is formed from regions of conductive material that are formed on opposite sides of the dielectric film resulting in a capacitor structure. The conductive traces are configured with printed
10 through-hole vias to provide electrical coupling from one side of the medical sensor to the other.

SUMMARY OF THE INVENTION

According to some embodiments of the invention the present invention there is
15 provided a sensor system. The system comprises: a solid substrate having a front side and a back side; a sensing assembly formed on the front side and being configured to provide electrochemical sensing; a plurality of electrical contacts, formed on the back side and being in electrical communication with the sensing assembly via a plurality of interconnects passing through the substrate and extending at least from the front side to
20 the back side; and a mounting member configured for mounting the back side onto a tip of a movable device.

According to some embodiments of the invention the movable device is a hand-held device.

According to some embodiments of the invention the movable device is a
25 movable arm of a robot.

According to some embodiments of the invention the movable device is an internal medical tool selected from the group consisting of an endoscope, a laparoscope and a cannula, and wherein the substrate is adapted for being introduced into the body of a mammal via endoscopic procedure.

30 According to some embodiments of the invention the movable device is an external medical tool.

According to some embodiments of the invention the substrate is sizewise comparable with the tip.

According to some embodiments of the invention the electrochemical sensing assembly comprises at least a working electrode, a reference electrode and a counter
5 electrode.

According to some embodiments of the invention the front side is non-adhesive to tissue.

According to some embodiments of the invention the interconnects have a shape selected from the group consisting of a generally conical shape, a generally cylindrical
10 shape, and an hourglass shape.

According to some embodiments of the invention the substrate is flexible.

According to some embodiments of the invention the system comprises further comprising the movable device.

According to some embodiments of the invention the mounting member
15 comprises an adhesive.

According to some embodiments of the invention the mounting member comprises a housing configured to receive the substrate at a front side of the housing and the hand-held device at a back side of the housing.

According to an aspect of some embodiments of the present invention there is provided a method which comprises providing a movable device and mounting the
20 sensor system described above, on the movable device using the mounting member.

According to an aspect of some embodiments of the present invention there is provided a method of sensing a target substance. The method comprises contacting the target substance with the sensor system as described above and receiving signals from
25 the plurality of electrical contacts, thereby sensing the target substance.

According to an aspect of some embodiments of the present invention there is provided a method of sensing a target substance. The method comprises maintaining a surface substantially at rest, placing a sensing assembly on the surface, and operating the sensing assembly for determining presence, absence or level of the target substance on
30 the surface; wherein the sensing assembly is formed on a front side of a solid substrate and being configured to provide electrochemical sensing; and wherein the operating the sensing assembly comprises receiving electrical signals from a plurality of electrical

contacts formed on a back side of the substrate and being in electrical communication with the sensing assembly via a plurality of interconnects passing through the substrate and extending at least from the front side to the back side.

According to some embodiments of the invention the placement of the sensing
5 assembly on the surface, comprising approaching the surface from above.

According to some embodiments of the invention the placement of the sensing assembly on the surface, comprising approaching the surface from the side.

According to some embodiments of the invention the surface is a skin surface of a living body.

10 According to some embodiments of the invention the surface is a surface of an internal organ of a living body, and wherein the placing is executed endoscopically or laparoscopically.

According to some embodiments of the invention the placement is executed in vitro.

15 According to an aspect of some embodiments of the present invention there is provided a sensor system. The system comprises: a movable device having a handle and a tip; a solid substrate, mounted on the tip and having a front side and a back side; a sensing assembly formed on the front side and being configured to provide electrochemical, electrobiochemical, pressure or electrical sensing; and at least one
20 electrical contact, formed on the back side and being in electrical communication with the sensing assembly via at least one interconnect passing through the substrate and extending at least from the front side to the back side.

Unless otherwise defined, all technical and/or scientific terms used herein have the same meaning as commonly understood by one of ordinary skill in the art to which
25 the invention pertains. Although methods and materials similar or equivalent to those described herein can be used in the practice or testing of embodiments of the invention, exemplary methods and/or materials are described below. In case of conflict, the patent specification, including definitions, will control. In addition, the materials, methods, and examples are illustrative only and are not intended to be necessarily limiting.

30 Implementation of the method and/or system of embodiments of the invention can involve performing or completing selected tasks manually, automatically, or a combination thereof. Moreover, according to actual instrumentation and equipment of

embodiments of the method and/or system of the invention, several selected tasks could be implemented by hardware, by software or by firmware or by a combination thereof using an operating system.

For example, hardware for performing selected tasks according to embodiments
5 of the invention could be implemented as a chip or a circuit. As software, selected tasks according to embodiments of the invention could be implemented as a plurality of software instructions being executed by a computer using any suitable operating system. In an exemplary embodiment of the invention, one or more tasks according to exemplary
10 embodiments of method and/or system as described herein are performed by a data processor, such as a computing platform for executing a plurality of instructions. Optionally, the data processor includes a volatile memory for storing instructions and/or data and/or a non-volatile storage, for example, a magnetic hard-disk and/or removable media, for storing instructions and/or data. Optionally, a network connection is provided as well. A display and/or a user input device such as a keyboard or mouse are optionally
15 provided as well.

BRIEF DESCRIPTION OF THE DRAWINGS

Some embodiments of the invention are herein described, by way of example only, with reference to the accompanying drawings. With specific reference now to the
20 drawings in detail, it is stressed that the particulars shown are by way of example and for purposes of illustrative discussion of embodiments of the invention. In this regard, the description taken with the drawings makes apparent to those skilled in the art how embodiments of the invention may be practiced.

In the drawings:

25 FIGs. 1A-D are schematic illustrations of a sensor system, according to some embodiments of the present invention;

FIGs. 2A-C are schematic illustrations of the sensor system in embodiments of the invention in which the electrodes are patterned and the interconnects are generally conical;

30 FIGs. 3A-C are schematic illustrations of the sensor system in embodiments of the invention in which the electrodes are circular and the interconnects are generally conical;

FIGs. 4A-C are schematic illustrations of the sensor system in embodiments of the invention in which the electrodes are circular and the interconnects are generally cylindrical;

FIGs. 5A-C are schematic illustrations of the sensor system in embodiments of the invention in which the system comprises a plurality of electrical leads for connecting the electrical contacts to a measuring device;

FIGs. 6A-C are schematic illustrations showing procedures for sensing a target substance on a surface, in embodiments of the invention in which the surface is approached from above;

FIGs. 7A-D are schematic illustrations showing procedures for sensing a target substance, in embodiments of the invention in which the target substance is above the sensor system;

FIGs. 8A-B are schematic illustrations of the sensor system in exemplary embodiments of the invention in which one or more of electrodes is coated;

FIGs. 9A-B are schematic illustrations of shadow masks applied at the front side of a substrate and vias are filled with conductive material;

FIGs. 10A-B are schematic illustrations of electrode metal deposited through the masks to form electrodes;

FIGs. 11A-E are schematic illustrations of a process suitable for fabricating a sensor system, according to some embodiments of the present invention;

FIG. 12 exemplifies Cyclic voltammogram in 10mM ferricyanide/ferrocyanide, 1M KNO₃ at different scans;

FIG. 13 shows amperometric response to addition of 1-NP in the presence of ALP, at 300mV as a function of Ag/AgCl; and

FIG. 14 shows amperometric detection of different ALP concentrations at 300mV and substrate (1-NP) concentration of 0.1mg/ml;

FIGs. 15A-B show an ECG signal as sensed by commercial stickers (FIG. 15A), and by a sensor system prepared according to some embodiments of the present invention (FIG. 15B); and

FIGs. 16A-F show results of experiments in which local field potential signals were sensed according to some embodiments of the present invention.

DESCRIPTION OF SPECIFIC EMBODIMENTS OF THE INVENTION

The present invention, in some embodiments thereof, relates to a sensor and, more particularly, but not exclusively, to a sensor that is placeable on an organ or a sample, and to method of fabricating and using such a sensor.

5 Before explaining at least one embodiment of the invention in detail, it is to be understood that the invention is not necessarily limited in its application to the details of construction and the arrangement of the components and/or methods set forth in the following description and/or illustrated in the drawings and/or the Examples. The invention is capable of other embodiments or of being practiced or carried out in various
10 ways.

Referring now to the drawings, FIGs. 1A-D illustrate a sensor system **10**, according to some embodiments of the present invention. System **10** comprises a solid substrate **100** having a front side, generally shown at **100a** (FIGs. 1A and 1C) and a back side generally shown at **100b** (FIG. 1B and 1D).

15 In various exemplary embodiments of the invention front side **100a** is made non-adhesive to tissue, optionally and preferably to skin-tissue.

The term “non-adhesive to tissue,” as used herein, refers to a surface of a substrate which is detachable from a tissue being in contact with the surface, wherein gravitational forces resulting only from the weight of the substrate are sufficient to effect
20 the detachment.

In some embodiments of the present invention cells and/or cell processes do not adhere to front side **100a** is at the molecular level.

Substrate **100** is optionally and preferably sizewise comparable with a tip **16** of a movable device **18**, such as, but not limited to, a hand-held device or a movable arm of a
25 robot. Device **18** can be, for example, an internal medical tool constituted for intracorporeal use, e.g., an endoscope, a laparoscope, a cannula, or an external medical tool constituted for extracorporeal use, e.g., a medical pen, a medical shaft or the like. In some embodiments of the present invention the largest dimension of substrate **100** is at most 2 mm or at most 1,5 mm or at most 1 mm or less.

30 Suitable materials for substrate **100** include, without limitation, a polymer, for example, an elastomeric polymer such as, but not limited to, polydimethylsiloxane (PDMS) and polytetrafluoroethylene (PTFE), silicone or the like.

System **10** further comprises a sensing assembly **12** formed on front side **100a**. In various exemplary embodiments of the invention sensing assembly **12** is configured to provide electrochemical sensing.

As used herein, “electrochemical sensing” refers to a process in which a sensible electrical signal is generated responsively to chemical reaction.

As used herein, “chemical reaction” refers to a reaction wherein one or more new species are produced by the chemical change of one or more components when certain conditions are provided for them to react.

The present embodiments contemplate electrochemical sensing which is effected by a process in which a sensible electrical signal is generated responsively to biochemical reaction. Such sensing is encompassed by the term electrochemical sensing and is referred to below as electrobiochemical sensing.

As used herein “biochemical reaction” refers to a reaction between two or more substances, wherein at least one of the substances is a biological material.

As used herein “biological material” refers to any material derived or obtained from a biological source, wherein the biological source has at least the complexity of a cell. In some embodiments of the present invention “biological material” refers to a material derived or obtained from a living organism.

According to some embodiments of the present invention electrobiochemical sensing is a process in which sensible electrical signal is generated responsively to biochemical reaction, wherein the biochemical reaction is a reaction that employs at least one of biological material selected from the group consisting of the product(s) of an amplification reaction, including both target and signal amplification, a purified sample, such as purified genomic DNA, RNA, protein, etc, a raw samples (bacteria, virus, genomic DNA, etc.), a biological molecular compound such as, but not limited to, a nucleic acid and related compounds (e.g., DNA, RNA, oligonucleotide or analogs thereof, PCR product, genomic DNA, bacterial artificial chromosome, plasmid and the like), a protein and related compounds (e.g. a polypeptide, a peptides, a monoclonal or polyclonal antibody, a soluble or bound receptor, a transcription factor, and the like), an antigen, a ligand, a hapten, a carbohydrate and related compounds (e.g. polysaccharide, a oligosaccharides and the like), a cellular fragment such as a membrane fragment, a cellular organelle, an intact cell, a bacteria, a virus, a protozoa, and the like.

In some embodiments of the present invention sensing assembly is configured for electrochemical sensing which all the reactants that participates in the chemical reaction are non-biological.

In some embodiments of the present invention sensing assembly is configured for pressure sensing, and in some embodiments of the present invention sensing assembly is configured for electrical sensing.

Pressure sensing can be used, for example, for measuring the rigidity of a target material. In embodiments of the invention in which sensing assembly **12** is configured for pressure sensing, substrate **100** is optionally and preferably made flexible, such that when assembly **12** is brought into contact with the substance it experiences a strain which depends on the rigidity of the target material. The strain can be detected, for example, as a change of electrical resistance, voltage or capacitance of sensor system **10**.

Electrical sensing can be used for measuring the potential of the target material. In these embodiments, when sensor system **10** is brought into contact with the substance a voltage potential can be generated and monitored. For example, healthy tissue and non-healthy tissue generate quantifiably different potentials which can then be output by the sensing system of the present embodiments.

Sensing assembly **12** comprises a plurality of electrodes. In the representative example shown in FIGs. 1A and 1C, assembly **12** comprises three electrodes designated by reference numerals **111**, **112** and **113**. For example, electrode **112** can be a working electrode, electrode **113** can be a counter electrode, and electrode **111** can be a reference electrode. The working electrode is the electrode at which the electrochemical or biochemical reaction occurs. Depending on the type of reaction, the working electrode can serve as a cathode or as an anode. Suitable materials for the working electrode including, without limitation, carbon (*e.g.*, glassy carbon, activated carbon cloth, carbon felt, platinized carbon cloth, plain carbon cloth), gold, platinum, silver and the like. The counter electrode is optionally and preferably, but not necessarily, made of the same material as the working electrode. The reference electrode can be a Silver/Silver Chloride electrode, a calomel (*e.g.*, saturated calomel) electrode, or the like.

Electrodes **111**, **112** and **113** are illustrated as patterned electrodes, wherein electrode **111** is shaped generally as a horseshoe, electrode **112** is generally circular and electrode **113** has the shape of a truncated oval. However, this need not necessarily be

the case, since, for some applications, it may not be necessary for the electrode to have those specific shapes or to be patterned. A representative example of a configuration with three circular electrodes is illustrated in FIGs. 3A-C. Further, although FIGs. 1A-D show a three electrode configuration, it is not intended to limit the scope of the present invention to a configuration with three electrodes.

In embodiments in which sensing assembly **12** provides electrobiochemical sensing, the biological material is preferably immobilized at the front side **100a** of substrate **100**, near or on one of the electrodes.

In various exemplary embodiments of the invention sensor system comprises a plurality of electrical contacts **14** formed on back side **100b** of substrate **100**. Contacts **14** are in electrical communication with sensing assembly **12** via a plurality of interconnects passing through substrate **100** and extending from front side **100a** to backside **100b**. The number of electrical contacts on back side **100b** is preferably the same as the number of electrodes in assembly **12**, such that each contact is in electrical communication with one electrode of assembly **12**, and is preferably devoid of any electrical communication with the other electrodes of assembly **12**. FIGs. 1B and 1D are schematic illustrations of an embodiment in which back side **100b** comprises three electrical contacts. In FIG, 1D, the three contacts are designated **114**, **115** and **116**. For example, contact **114** can be in electrical communication with electrode **111**, contact **115** can be in electrical communication with electrode **112**, and contact **116** can be in electrical communication with electrode **113**.

The interconnects of system **10** are illustrated in FIGs. 2A-C., where FIG. 2A shows front side **100a**, FIG. 2B is a cross-sectional view of substrate **100** along the line A-A in FIG. 2A, and FIG. 2C is a cross-sectional view of substrate **100** along the line B-B in FIG. 2A. FIGs. 2A-C correspond to a three-electrode configuration. In this configuration, system **10** preferably comprises three interconnects shown at **117**, **118** and **119**. FIGs. 2B and 2C illustrate interconnects having a generally conical shape. Other interconnect shapes, including, without limitation, generally cylindrical shape and hourglass shapes, are not excluded from the scope of the present invention.

A representative example of a three-electrode configuration in which the electrodes are circular and the interconnects are generally cylindrical are illustrated in FIGs. 4A-C.

System **10** optionally and preferably comprises a mounting member **20** configured for mounting back side **100b** onto a movable device **18**. Mounting member **20** is shown in FIG. 1B as a housing which receives substrate **100** at a front side **20a** of the housing and device **18** at the back side **20b** of the housing. Other types of mounting members are not excluded from the scope of the present invention. For example, mounting member can comprise an adhesive selected to adhere back side **100b** on device **18**.

Before providing a further detailed description of the sensor system of the present embodiments, attention will be given to the advantages and potential applications offered thereby.

Sensor system **10** optionally and preferably allows monitoring secreted analytes by approaching from their upper surface. Conventional integrated electrodes, particularly those that provide electrochemical sensing, include electrodes and electrical contacts patterned on the top surface of a substrate. This configuration requires the integration of cells with the electrode's surface and the measurement of analytes secreted into the contact region. This process requires a preliminary step of detachment of the cells to be tested from their origin, and results in poor signal-to-noise ratio. Signal strength and device sensitivity can be increased by minimizing the gap between the cells and the sensor.

The present embodiments overcome at least a few of these limitations. The sensor system of the present embodiments comprises sensing electrodes on a substrate which can be placed on an exposed surface of a sample, wherein the signals are output from the opposite side of the substrate (not in contact with the sample). Thus signals flow along a path perpendicular to the substrate and sample being measured. Electrical communication between the electrodes on one side of the substrate and electrical contacts at the opposite side of the substrate can be established by interconnects, interchangeably referred to herein as vias.

The approach of the present embodiments paves the way to perform direct, non-invasive diagnostics of an exposed cell layer both for *in-vivo* and *in-vitro* applications. The system of the present embodiments is useful for many medical and health care applications.

Thus, in use, sensor system **10** can be mounted on a hand-held device using the mounting member **20**. A target substance, such as, but not limited to, a cell can be contacted with the sensing assembly and electrical signals can be received from the electrical contacts **114**, **115** and **116**. The signals can be measured by any technique
5 known in the art including, without limitation, chrono-amperometry, chrono-potentiometry, cyclic voltammetry, chrono-coulometry and square wave voltammetry.

FIGs. 5A-C are schematic illustrations of system **10** in embodiments of the invention in which system **10** comprises a plurality of electrical leads **211**, **212** and **213** for connecting electrical contacts **114**, **115** and **116** to a measuring device **22**. The
10 electrical leads are made of a conductive material such as a metal, and can be made flexible or rigid as desired. In embodiments in which system **10** comprises housing **20**, the leads optionally and preferably occupy the interior of housing **20**, as illustrated in FIGs. 5A-C.

Measuring device **22** typically comprises an electronic circuit **23** configured for
15 receiving and measuring the electrical signal from the electrical contacts. Measuring device **22** can be encapsulated within housing **20** or it can be external to housing **20**.

The measuring device optionally and preferably communicates with a data processor **25** supplemented by software for receiving, analyzing and presenting data pertaining to the measurement.

As used herein, "data processor" includes any suitable device for processing data,
20 including, without limitation, a microcomputer, a microprocessor, and a data processing system. A data processor can be electronic computing circuitry (e.g., a central processing unit) or a system associated with such circuitry. Representative examples include, without limitation, a desktop home computer, a workstation, a laptop computer
25 and a notebook computer. Also contemplated is a dedicated system having electronic computing circuitry therein. Optionally, such a dedicated system is portable. Optionally, such a dedicated system is hand held or wearable, e.g., on the arm of the user. Also contemplated are systems which are capable of receiving and processing data but may also have other functions. Representative examples include, without limitation,
30 a cellular telephone with data processing functionality (also known as a smartphone), a personal digital assistant (PDA) with data processing functionality, a portable email device with data processing functionality (e.g., a BlackBerry® device), a portable media

player with data processing functionality (e.g., an Apple iPod®), a portable gaming device with data processing functionality (e.g., a Gameboy®), and a tablet or touch screen display device with data processing functionality (e.g., an Apple iPad®, the Motorola Xoom®, Samsung Galaxy®, and the TabletKiosk Sahara NetSlate®).

5 The communication between data processor **25** and measuring device **22** is optionally and preferably by an electronic signal is transmitted through an interface such as, but not limited to, an IEEE 1394 interface, a USB interface, a wireless interface and the like. Wireless interface may feature, for example, Bluetooth communication, IEEE 802.11(b) (WiFi) communication, Wi-Max communication, or wireless USB
10 communication.

 Data processor **25** is preferably supplemented by software programmed for receiving electrical signals from measuring device **22**, analyzing the signal and presenting an output pertaining to the analysis. The software is optionally and preferably also designed for providing a virtual user interface, *e.g.*, by means of a touch
15 or multi-touch screen, so as to allow the user to interact with the data processor.

 In some embodiments of the present invention the leads are not in contact with the electrical contacts. Prior to sensing, leads can be engaged to make contact with the electrical contacts. The engagement can be realized by an engaging mechanism **32** configured to push the leads toward the electrical contacts (FIG. 5C). Mechanism **32**
20 can be of the type typically used in, for example, a retractable ballpoint pen.

 FIGs. 6A-C are schematic illustrations showing procedures for sensing a target substance **24** on a surface **26**. Existence, absence or level of target substance **24** on surface **26** can be sensed, according to some embodiments of the present invention, by placing sensing assembly **12** of sensor system **10** on the surface while maintaining the
25 surface substantially at rest. For example, sensor system **10** can approach the surface from above or from the side or from below. In the embodiments illustrated in FIGs. 6A-C, system **10** approaches surface **26** from above. As shown, sensor system **10** is placed on top of surface **26** such that surface **26** is below sensor system **10**.

 Surface **26** can be, for example, a skin surface of a living body, in which case
30 sensor system **10** is preferably mounted on an external medical tool constituted for extracorporeal use, *e.g.*, a medical pen, a medical shaft or the like. The surface can alternatively be an internal organ of a living body, in which case sensor system **10** is

preferably mounted on an endoscope or a laparoscope, and the placement is executed endoscopically or laparoscopically. Still alternatively, the placement can be executed *in vitro*.

The sensing of substance **24** can be in the presence of a fluid or gel medium **321** as illustrated in FIG. 6B. Representative examples of fluid media including, without limitation, saliva, blood, urine and buffer solution. Representative examples of gel media including, without limitation, conductive gel, *e.g.*, ultrasound gel, polyacrylamide. In these embodiments, medium **321** is optionally and preferably applied to surface **26** before approaching the surface with system **10**. Alternatively the gel medium can be dispensed by, or through, sensor system **10**. In some embodiments of the present invention substrate **100** is made flexible. These embodiments are advantageous since the flexibility of substrate **100** allows sensing assembly to conform with the shape, or to measure the mechanical stiffness, of substance **24** and/or surface **26**, as illustrated in FIG. 6C.

While FIGs. 6A-C illustrates embodiments in which sensor system **10** is above substance **24**, it is to be understood other positional relations between system **10** and substance **24** are not excluded from the scope of the present invention. FIGs. 7A-D illustrate embodiment of the invention in which the target substance is above system **10**. FIG. 7A illustrates an embodiment in which a sample **28** (*e.g.*, a tissue sample or a cell) to be analyzed is placed on sensor system **10**. FIG. 7B illustrates an embodiment in which two or more sensor systems, each being similar or the same as sensor system **10**, operate together. As shown, a sample to be analyzed is placed on each of the systems. FIGs. 7C-D illustrate an embodiment of the invention in which a plurality of sensor systems, each being similar or the same as sensor system **10**, is integrated in a respective plurality of wells arranged as an array **400**. For example, the wells can be wells of a microwell plate wherein the sensor system of the present embodiments is integrated on the base of each well.

FIGs. 8A-B are schematic illustrations of system **10** in exemplary embodiments of the invention in which one or more of electrodes **111**, **112** and **113** is coated.

In some embodiments of the present invention electrodes **111**, **112** and **113** are coated by metal layers **120**, **121** and **122**, respectively, and the reference electrode (electrode **111** in the present example) is further coated by a layer **131** of a reference

material. Suitable materials for use as a metal layer include, without limitation, carbon (*e.g.*, glassy carbon, activated carbon cloth, carbon felt, platinized carbon cloth, plain carbon cloth), gold, platinum, silver and the like. Suitable reference materials include, without limitation, Silver/Silver Chloride electrode, a calomel (*e.g.*, saturated calomel) electrode, or the like. A typical thickness for layers **120**, **121** and **122** is from about 100nm to about 7 μ m. A typical thickness for layer **131** is from about 100nm to about 7 μ m.

Sensor system **10** of the present embodiments can be fabricated in more than one way.

In some embodiments of the present invention a mold is fabricated, for example, using a three-dimensional fabrication process (*e.g.*, stereolithography, 3D printing) and the like. A representative example of a mold **140** suitable for use according to some embodiments of the present invention is illustrated in FIGs. 11A (perspective view) and 11B (cross sectional view). The mold preferably includes shaped protrusions **142** at the locations of the interconnects. The shapes of protrusions **142** is the same as the shape of the interconnects to be formed (*e.g.*, cylindrical, conical, hourglass), as further detailed hereinabove. Optionally and preferably, the mold also comprises a relief pattern **144** at the bases of protrusions **142**, wherein the shape of pattern **144** is the same as the shape of the electrodes to be formed as further detailed hereinabove. A polymeric material, such as, but not limited to, PDMS can then be introduced into the mold and cured thereafter to form a patterned substrate, with vias at the locations of protrusions **142** and with grooves at the locations of pattern **144**. FIG. 11C is a cross sectional view of mold **140**, following the introduction of a polymeric material **146** into the mold. Following curing, the patterned substrate can be separated from the mold. FIG. 11D illustrates the patterned substrate **100**, including the vias (generally shown at **148**) and the grooves (generally shown at **150**), following the separation between the substrate and the mold.

A conductive composition can be patterned on the substrate, to fill the vias and grooves, as illustrated in FIG. 11E. A metallization process can then be employed to form the electrodes and electrical contacts. A stencil or shadow mask defining the electrodes can then be fabricated, for example, from a polyimide film, metal, plastic and glass. Any metallization process can be employed, including, without limitation, sputter deposition, evaporation and electroplating. Preferably, a reference electrode is also

fabricated as known in the art. In a representative embodiment, a metal plating is followed by chloridation and anodization.

The conductive composition optionally and preferably comprises a polymer and an electrically conductive additive. The weight or volume ratio between the polymer and the additive can be selected based on the desired conductivity and mechanical characteristics of the conductive composition, as known in the art. In some embodiments of the present invention a conductive PDMS, which include a mixture of PDMS and an electrically conductive additive, is used. In experiments performed by the present inventors a conductive PDMS was form by mixing PDMS with graphite. Other electrically conductive additives suitable for the present embodiments include, without limitation, ethylenedioxythiophene (EDOT), poly(3,4-ethylenedioxythiophene) (PEDOT), PEDOT doped with poly(styrenesulfonate), polyaniline, poly(pyrrole), poly(acetylene), poly(thiophene), poly(p-phenylene sulfide), poly(para-phenylene vinylene), polyindole, polypyrene, polycarbazole, polyazulene, polyazepine and polynaphthalene.

An alternative fabrication process suitable for some embodiments of the present invention includes deposition of metal, *e.g.*, gold on the front side of a silicon wafer. The other side can be patterned with lithographic techniques to define the interconnects. Vias can be etched using any suitable etching process, such as, but not limited to, wet chemical etching, dry chemical etching and physical etching. The etching is preferably termination when the metal layer on the front side is reached. The vias can alternatively formed by drilling, *e.g.*, by laser ablation. The thus formed vias can then be filled with conductive material, *e.g.*, a metal, such as, but not limited to, gold. This can be done, for example, by electroplating technique. The metal layer on the front side can then be patterned, *e.g.*, by lithography, and etched to define the electrodes. Preferably, a reference electrode is also fabricated as known in the art.

FIGs. 9A-B are schematic illustrations of a stage in the fabrication process in which shadow masks **181** are formed at the front side **100a** after the vias **117**, **118** and **119** are filled with conductive material. The metal can be deposited through shadow masks **181**. FIGs. 10A-B are schematic illustrations of a stage in the fabrication process after the metal deposition, wherein the electrode metal is deposited through the masks to form electrodes **111**, **112** and **113**.

As used herein the term "about" refers to $\pm 10\%$.

The word "exemplary" is used herein to mean "serving as an example, instance or illustration." Any embodiment described as "exemplary" is not necessarily to be construed as preferred or advantageous over other embodiments and/or to exclude the
5 incorporation of features from other embodiments.

The word "optionally" is used herein to mean "is provided in some embodiments and not provided in other embodiments." Any particular embodiment of the invention may include a plurality of "optional" features unless such features conflict.

The terms "comprises", "comprising", "includes", "including", "having" and their
10 conjugates mean "including but not limited to".

The term "consisting of" means "including and limited to".

The term "consisting essentially of" means that the composition, method or structure may include additional ingredients, steps and/or parts, but only if the additional ingredients, steps and/or parts do not materially alter the basic and novel characteristics
15 of the claimed composition, method or structure.

As used herein, the singular form "a", "an" and "the" include plural references unless the context clearly dictates otherwise. For example, the term "a compound" or "at least one compound" may include a plurality of compounds, including mixtures thereof.

Throughout this application, various embodiments of this invention may be
20 presented in a range format. It should be understood that the description in range format is merely for convenience and brevity and should not be construed as an inflexible limitation on the scope of the invention. Accordingly, the description of a range should be considered to have specifically disclosed all the possible subranges as well as individual numerical values within that range. For example, description of a range such
25 as from 1 to 6 should be considered to have specifically disclosed subranges such as from 1 to 3, from 1 to 4, from 1 to 5, from 2 to 4, from 2 to 6, from 3 to 6 etc., as well as individual numbers within that range, for example, 1, 2, 3, 4, 5, and 6. This applies regardless of the breadth of the range.

Whenever a numerical range is indicated herein, it is meant to include any cited
30 numeral (fractional or integral) within the indicated range. The phrases "ranging/ranges between" a first indicate number and a second indicate number and "ranging/ranges from" a first indicate number "to" a second indicate number are used herein

interchangeably and are meant to include the first and second indicated numbers and all the fractional and integral numerals therebetween.

It is appreciated that certain features of the invention, which are, for clarity, described in the context of separate embodiments, may also be provided in combination in a single embodiment. Conversely, various features of the invention, which are, for brevity, described in the context of a single embodiment, may also be provided separately or in any suitable subcombination or as suitable in any other described embodiment of the invention. Certain features described in the context of various embodiments are not to be considered essential features of those embodiments, unless the embodiment is inoperative without those elements.

Various embodiments and aspects of the present invention as delineated hereinabove and as claimed in the claims section below find experimental support in the following examples.

EXAMPLES

Reference is now made to the following examples, which together with the above descriptions illustrate some embodiments of the invention in a non limiting fashion.

Example 1

PDMS substrate with cPDMS interconnects

Mold fabrication

Initial negative molds were fabricated using a three-dimensional printing process (Objet Connex500™ 3D printing system) from a rigid white polymer (VeroWhitePlus™, in the present example). The molds were then cleaned in a 2% NaOH Solution for at least 30 minutes.

Mask design

A stencil or shadow mask defining the electrodes was drawn using 2D CAD software. The masks were fabricated from polyimide film of 25-75 micron thicknesses. Alternatively, metal, plastic, glass, etc. masks may be used.

Preparation of PDMS Substrates

PDMS (10:1 v/v mixture of Sylgard 184 and its curing agent) was poured into the mold after degassing. The sample was then heated to 55°C for two hours for curing.

Preparation of conductive PDMS (cPDMS)

5 PDMS (10:1) was mixed with graphite powder to obtain graphite concentration of ~60 wt%. The substrate trenches and patterns were filled with the cPDMS mixture and curing was at 80°C for at least 8 hours.

Electrode/contact metallization

Sputter deposition

10 The PDMS substrate was placed on a handle wafer with the electrode side facing up. A stencil or shadow mask was placed on the PDMS substrate. An oxygen plasma (5 SCCM, 150 W) was performed for 30 seconds. The substrate was loaded into an ion beam sputterer and 100-300 nm of gold was sputtered onto the exposed cPDMS electrodes.

Electroplating

15 In a different experiment, a three-electrode cell containing working electrode (WE), counter electrode (CE) and reference electrode (RE) was fabricated by an electroplating process. The PDMS substrate with cPDMS filled vias was placed in a gold plating bath containing KAu(CN)_2 – 10 g/l of Au. Electrical contact was made with
20 the contact side of the vias and gold was electroplated on the electrode side of the vias.

Reference electrode preparation

After sputtering, or electroplating, the formation of reference electrode Ag/AgCl was prepared by a double step process including silver plating of the gold substrate and chloridation of the plated silver. The plating was performed and successfully coated the
25 reference electrode (surface area 4mm^2). Immediately after plating of Ag, the Ag electrode was subjected to anodization in HCl for the generation of AgCl salt layer and completion of an Ag/AgCl open reference electrode.

Example 2

Silicon substrate with vias filled by electroplating

Via fabrication

30 Gold is deposited on one side of a silicon wafer. The other side of the silicon wafer is patterned with lithographic techniques to define the via interconnects. The vias

are etched with wet chemical, dry chemical or physical etching until the deposited gold layer is reached. The wafer is placed in an electroplating bath and the vias are filled by electroplating. Chemical mechanical polishing (CMP) is used to create a smooth, uniform surface.

5 Electrode patterning

The deposited gold layer is lithographically patterned and etched to define the electrodes.

Reference electrode preparation

After the electrodes are patterned the reference electrode Ag/AgCl is prepared by
10 a two-step process of electroplating silver on the reference electrode followed by the chloridation of the plated silver – i.e. the Ag electrode is subjected to anodization in HCl generating an AgCl salt layer thereby completing the Ag/AgCl open reference electrode.

Example 3

Characterization of the sensor system

15 A polymer based sensor system was fabricated in accordance with the embodiments of the present invention described in Example 1 above. The electrochemical behavior of the sensor system was evaluated using cyclic voltammetry analysis in the presence of a redox couple of ferrocyanide/ferricyanide electroactive solution.

20 The parameters were set as follows: the initial potential was set to $E=0V$, the first switching potential was set to $E=0.6V$ and the second switching potential set to $E=-0.3V$. The potential step was set to $E=0.005V$ and scan rates between 25 and 150 mVs^{-1} in 1M KNO_3 . Measurements were performed with a PalmSens® portable potentiostat (Palm Instruments BV, the Netherlands).

25 FIG. 12 exemplifies Cyclic voltammogram in 10mM ferricyanide/ferrocyanide, 1M KNO_3 for different scans.

Amperometric detection of the substrate 1-NP was carried out by applying a fixed potential of 0.3 V under a stirred solution. Upon reaching stabilization of the background signal a final concentration of 0.1 mg/ml 1-NP was added. In addition, the
30 determination of ALP activity was carried out by adding the final concentrations of ALP: 10, 1 and 0.5 $\mu g/ml$ to the chamber.

FIG. 13 shows amperometric response to addition of 1-NP in the presence of ALP, at 300mV as a function of Ag/AgCl, and FIG. 14 shows amperometric detection of different ALP concentrations at 300mV and substrate (1-NP) concentration of 0.1mg/ml.

The sensor of the present embodiments provides electrochemical signals with high signal-to-noise ratio. High level of adhesion between the gold and the cPDMS was observed. The mechanical properties of cPDMS match those of the PDMS substrate and bending or flexing did not change properties or cause cPDMS to delaminate or crack. The electrode was stable for at least three weeks in storage.

Example 4

Electrical Sensing

A polymer based sensor system having a flexible substrate and Au/AgPDMS electrodes was fabricated in accordance with the embodiments of the present invention described in Example 1 above.

Electrocardiogram (ECG) signal

The sensor system was placed on the surface of the skin of a volunteer in the presence of electrolyte gel, and ECG signal was recorded by an external device. For comparison, commercial ECG stickers (SKINTACT ECG Electrode F-RG1 /6) were also attached to the skin of the same volunteer.

FIG. 15A shows an ECG signal as sensed by the commercial stickers, and FIG. 15B shows an ECG signal as sensed by the sensor system of the present embodiments. As shown the signal quality and signal-to-noise-ratio (SNR) were higher for the sensor system optionally and preferably than for the commercial sticker.

Local field potential measurement

A local field potential (LFP) is a particular class of electrophysiological signals, which is dominated by the electrical current flowing from all nearby dendritic synaptic activity within a volume of tissue.

The sensor system of the present embodiments was used for sensing LFP signal from a rat brain. For comparison, a commercial LFP sensor (5M Ω at 1kHz tungsten electrode by A-M Systems) was also used to record LFP signal from the same rat.

The results are shown in FIGs. 16A-F for LFP signals sensed by the commercial sensors (FIGs. 16A, 16C and 16E) and the sensor system of the present embodiments

(FIGs. 16B, 16D and 16F), where FIGs. 16A and 16B show example trials, FIGs. 16C and 16D show average waveforms, and FIGs. 16E and 16F show power spectra.

Although the invention has been described in conjunction with specific
5 embodiments thereof, it is evident that many alternatives, modifications and variations will be apparent to those skilled in the art. Accordingly, it is intended to embrace all such alternatives, modifications and variations that fall within the spirit and broad scope of the appended claims.

All publications, patents and patent applications mentioned in this specification
10 are herein incorporated in their entirety by reference into the specification, to the same extent as if each individual publication, patent or patent application was specifically and individually indicated to be incorporated herein by reference. In addition, citation or identification of any reference in this application shall not be construed as an admission that such reference is available as prior art to the present invention. To the extent that
15 section headings are used, they should not be construed as necessarily limiting.

WHAT IS CLAIMED IS:

1. A sensor system, comprising:
 - a solid substrate having a front side and a back side;
 - a sensing assembly formed on said front side and being configured to provide electrochemical sensing;
 - a plurality of electrical contacts, formed on said back side and being in electrical communication with said sensing assembly via a plurality of interconnects passing through said substrate and extending at least from said front side to said back side; and
 - a mounting member configured for mounting said back side onto a tip of a movable device.
2. The system according to claim 1, wherein said movable device is a hand-held device.
3. The system according to claim 1, wherein said movable device is a movable arm of a robot.
4. The system according to any of claims 1-3, wherein said movable device is an internal medical tool selected from the group consisting of an endoscope, a laparoscope and a cannula, and wherein said substrate is adapted for being introduced into the body of a mammal via endoscopic procedure.
5. The system according to any of claims 1-3, wherein said movable device is an external medical tool.
6. The system according to any of claims 1-3, wherein said substrate is sizewise comparable with said tip.
7. The system according to claim 6, wherein said electrochemical sensing assembly comprises at least a working electrode, a reference electrode and a counter electrode.

8. The system according to any of claims 1-3, wherein said front side is non-adhesive to tissue.

9. The system according to any of claims 4-6, wherein said front side is non-adhesive to tissue.

10. The system according to any of claims 1-3, wherein said electrochemical sensing assembly comprises at least a working electrode, a reference electrode and a counter electrode.

11. The system according to claim 10, wherein said interconnects have a shape selected from the group consisting of a generally conical shape, a generally cylindrical shape, and an hourglass shape.

12. The system according to any of claims 1-7, wherein said interconnects have a shape selected from the group consisting of a generally conical shape, a generally cylindrical shape, and an hourglass shape.

13. The system according to any of claims 1-3, wherein said substrate is flexible.

14. The system according to any of claims 4-12, wherein said substrate is flexible.

15. The system according to any of claims 1-3, further comprising said movable device.

16. The system according to any of claims 4-14, further comprising said movable device.

17. The system according to any of claims 1-3, wherein said mounting member comprises an adhesive.

18. The system according to any of claims 4-16, wherein said mounting member comprises an adhesive.

19. The system according to any of claims 1-3, wherein said mounting member comprises a housing configured to receive said substrate at a front side of said housing and said movable device at a back side of said housing.

20. The system according to any of claims 4-18, wherein said mounting member comprises a housing configured to receive said substrate at a front side of said housing and said movable device at a back side of said housing.

21. A method, comprising providing a movable device and mounting the sensor system according to any of claims 1-3, on said hand-held device using said mounting member.

22. A method, comprising providing a movable device and mounting the sensor system according to any of claims 4-20 on said movable device using said mounting member.

23. A method of sensing a target substance, comprising contacting the target substance with the system according to any of claims 1-3, and receiving signals from said plurality of electrical contacts, thereby sensing the target substance.

24. A method of sensing a target substance, comprising contacting the target substance with the system according to any of claims 4-20, and receiving signals from said plurality of electrical contacts, thereby sensing the target substance.

25. A method of sensing a target substance, comprising maintaining a surface substantially at rest, placing a sensing assembly on said surface, and operating said sensing assembly for determining presence, absence or level of the target substance on said surface;

wherein said sensing assembly is formed on a front side of a solid substrate and being configured to provide electrochemical sensing; and

wherein said operating said sensing assembly comprises receiving electrical signals from a plurality of electrical contacts formed on a back side of said substrate and being in electrical communication with said sensing assembly via a plurality of interconnects passing through said substrate and extending at least from said front side to said back side.

26. The method according to claim 25, wherein said placing said sensing assembly on said surface, comprising approaching said surface from above.

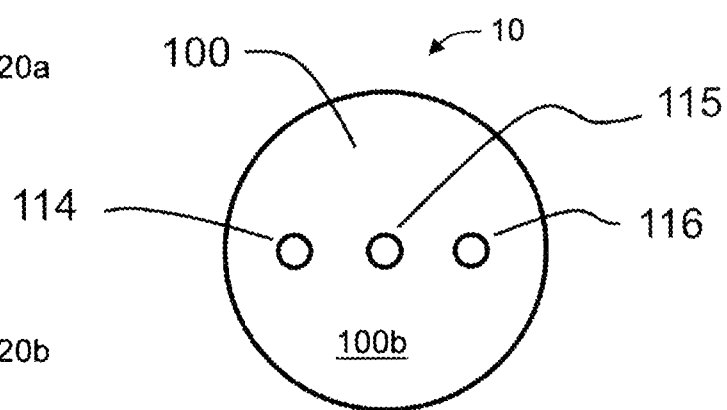
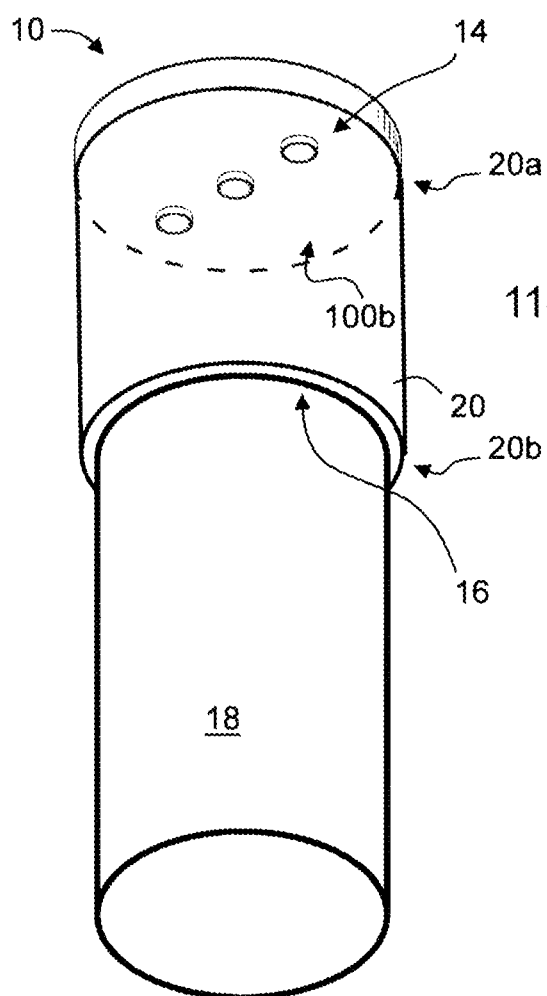
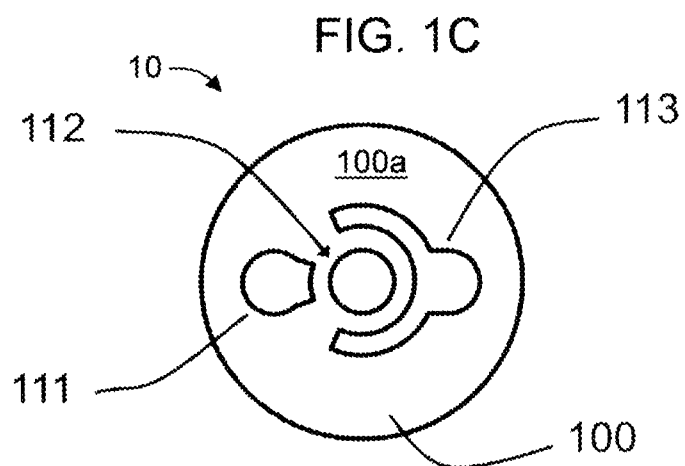
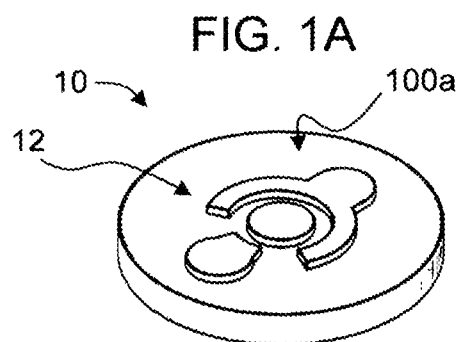
27. The method according to claim 25, wherein said placing said sensing assembly on said surface, comprising approaching said surface from the side.

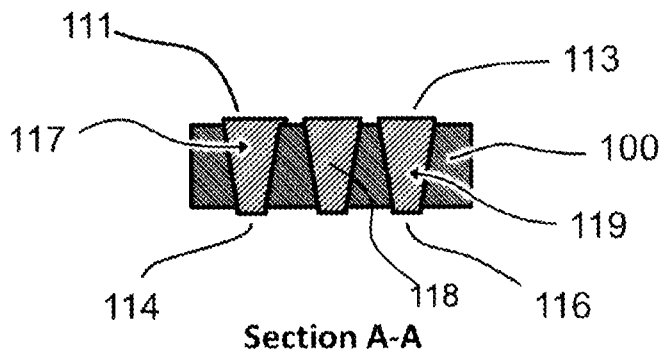
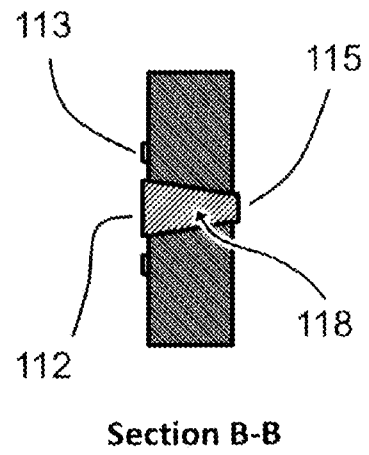
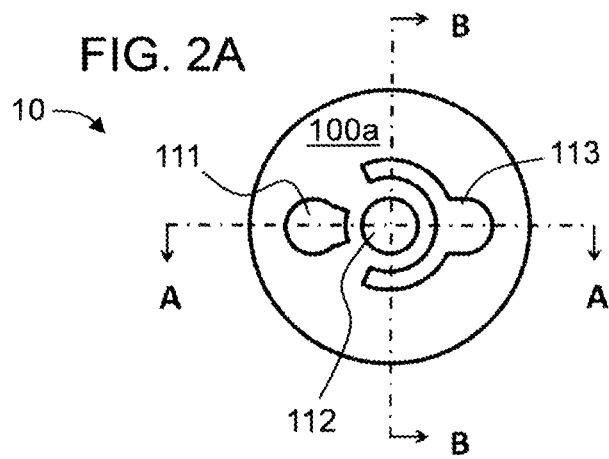
28. The method according to any of claims 25-27, wherein said surface is a skin surface of a living body.

29. The method according to any of claims 25-27, wherein said surface is a surface of an internal organ of a living body, and wherein said placing is executed endoscopically or laparoscopically.

30. The method according to any of claims 25-27, wherein said placing is executed *in vitro*.

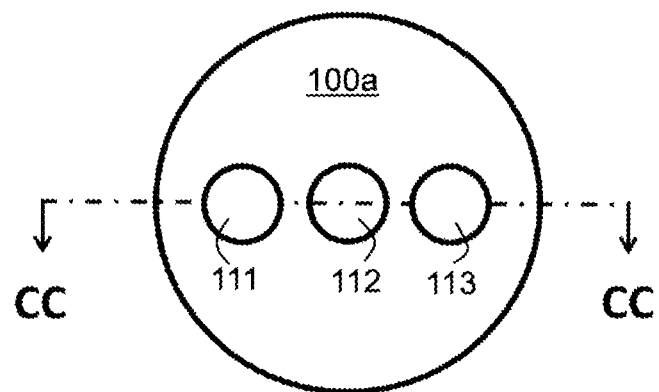
31. A sensor system, comprising:
a movable device having a handle and a tip;
a solid substrate, mounted on said tip and having a front side and a back side;
a sensing assembly formed on said front side and being configured to provide electrochemical, electrobiochemical, pressure or electrical sensing; and
at least one electrical contact, formed on said back side and being in electrical communication with said sensing assembly via at least one interconnect passing through said substrate and extending at least from said front side to said back side.



**FIG. 2C****FIG. 2B**

10

FIG. 3A



10

FIG. 3B

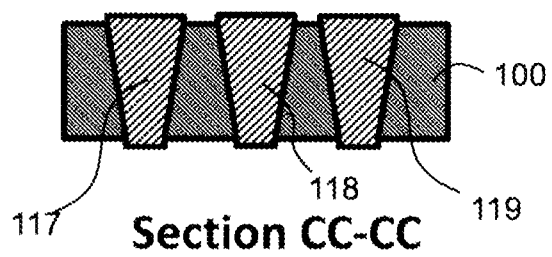
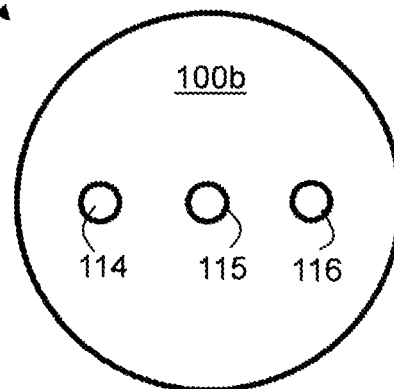


FIG. 3C

FIG. 4A

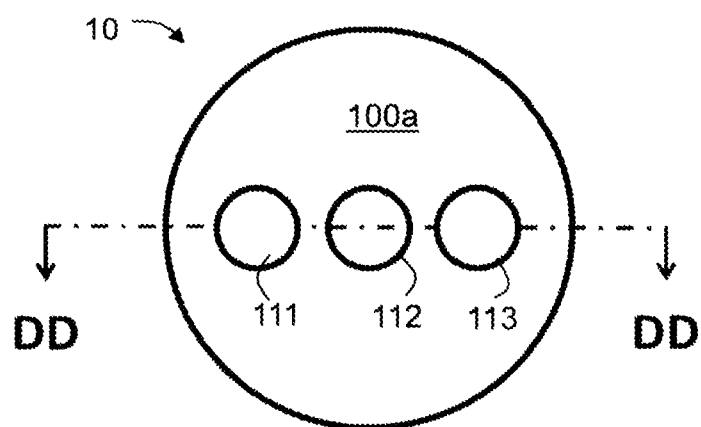
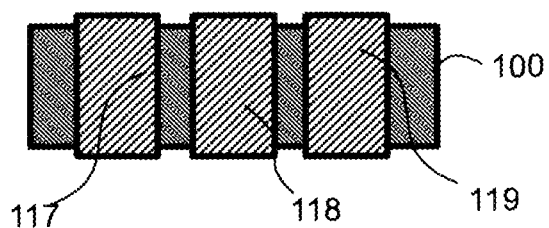
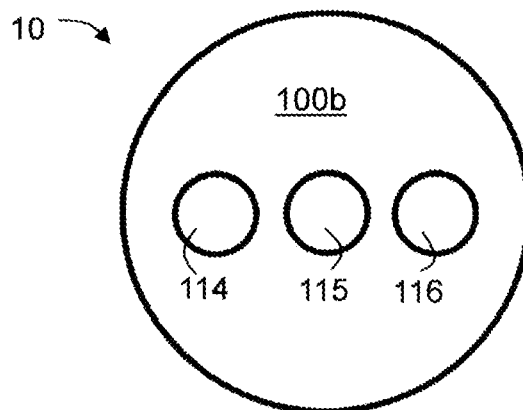


FIG. 4B



Section DD-DD

FIG. 4C

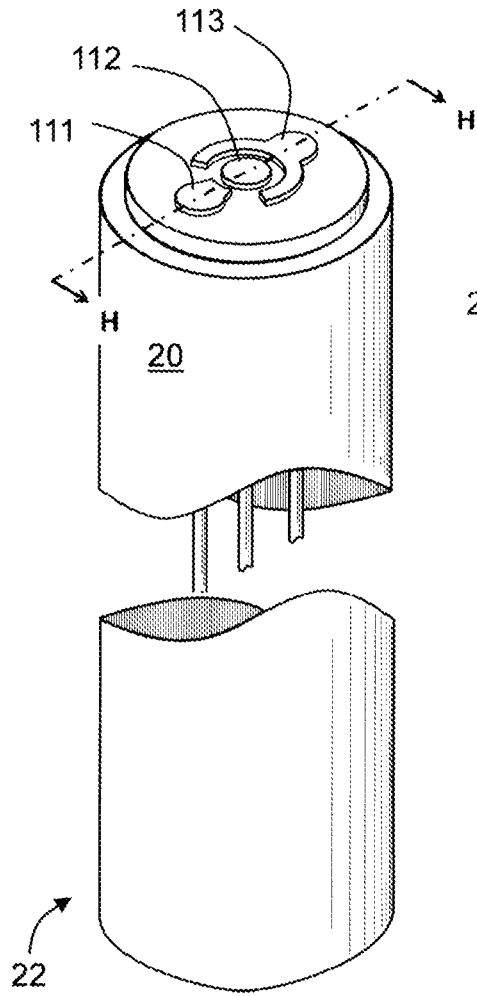


FIG. 5A

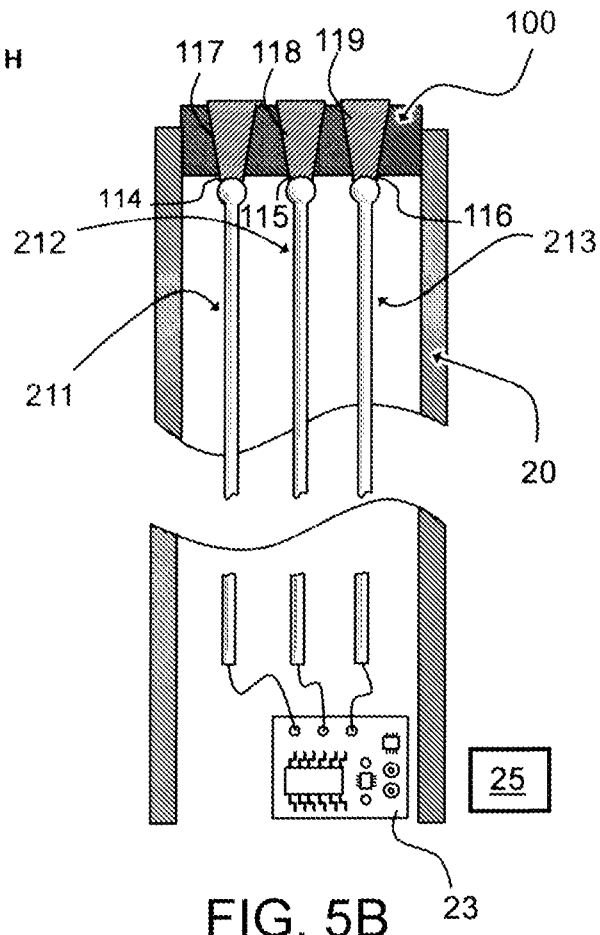
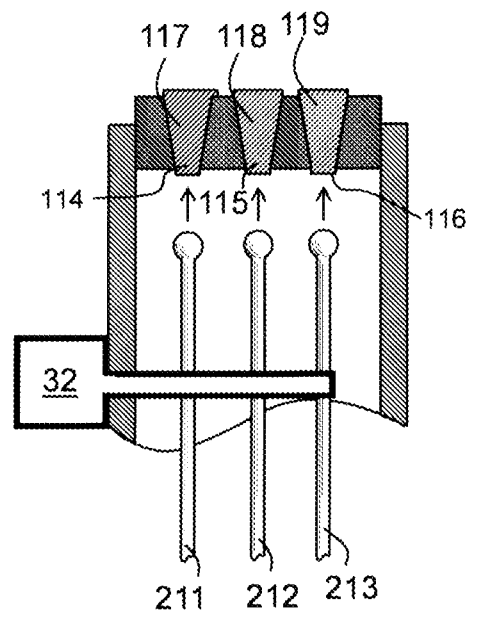


FIG. 5B

FIG. 5C



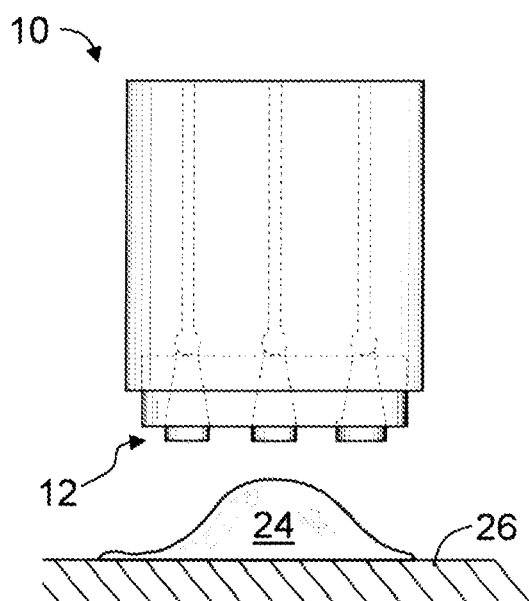


FIG. 6A

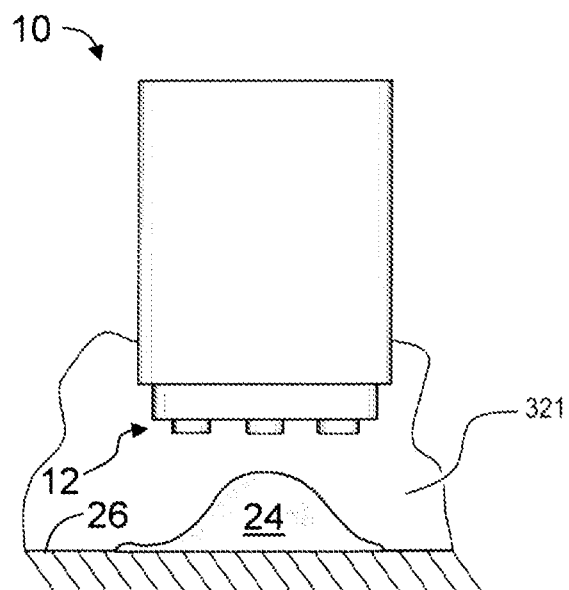


FIG. 6B

FIG. 6C

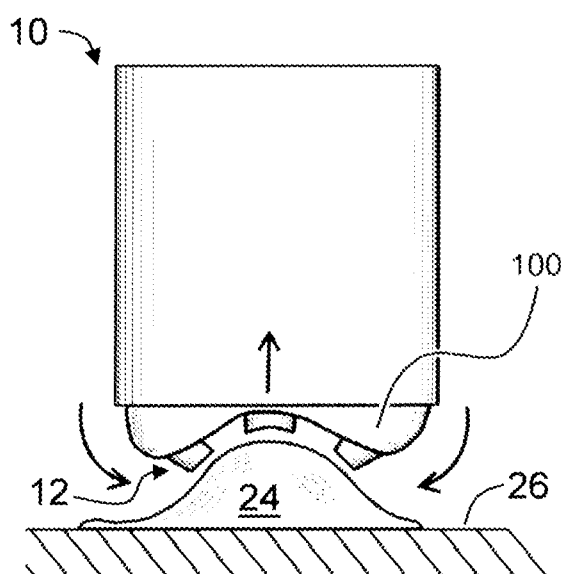


FIG. 7A

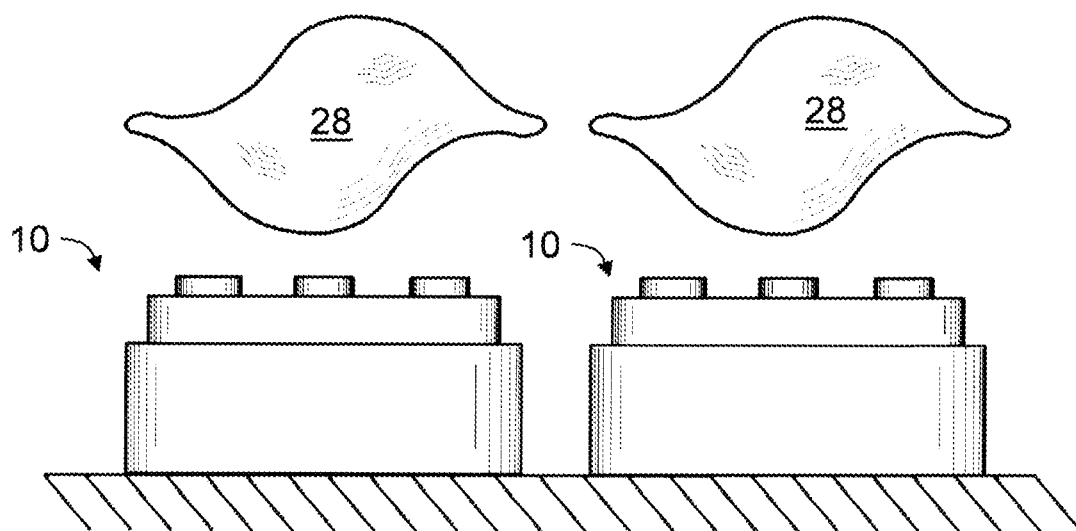
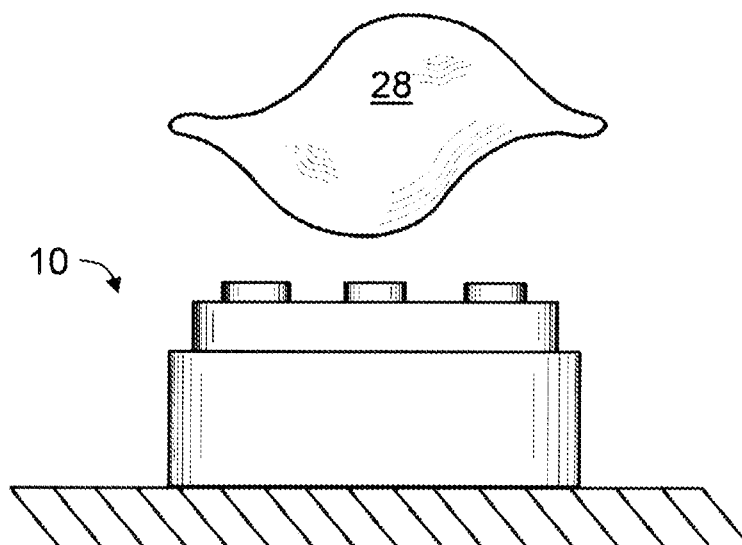


FIG. 7B

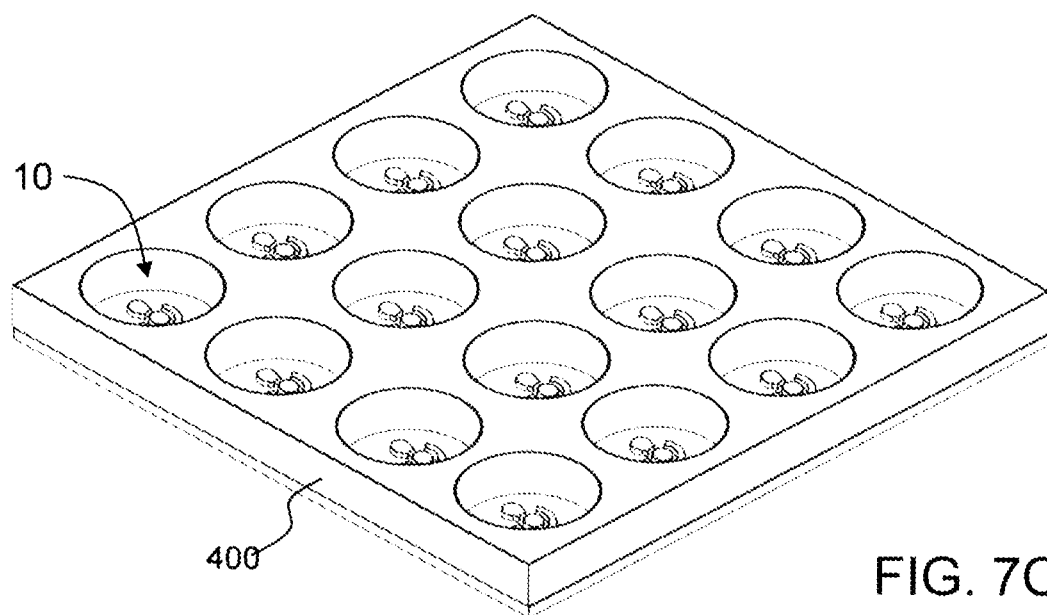


FIG. 7C

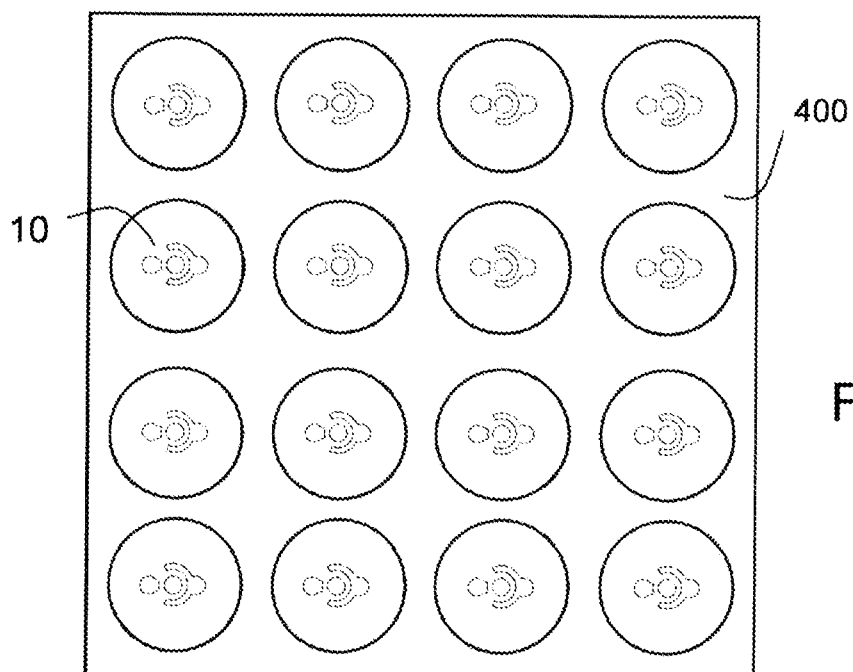


FIG. 7D

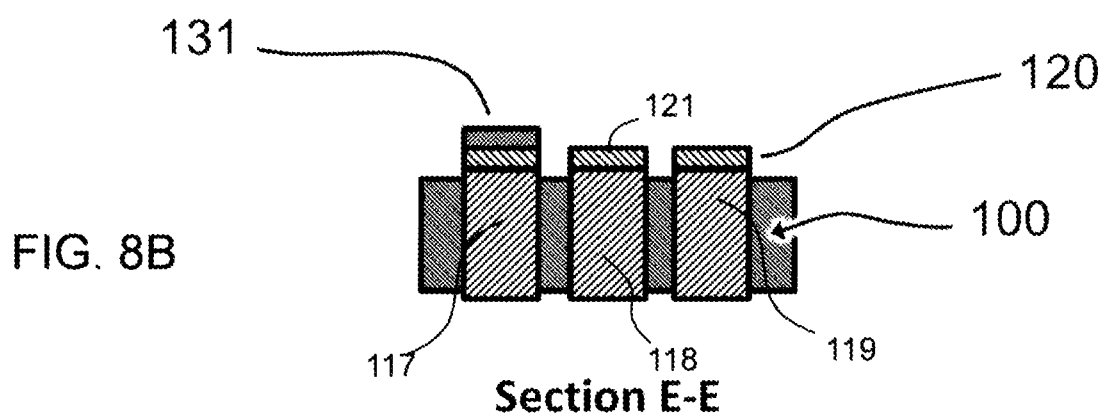
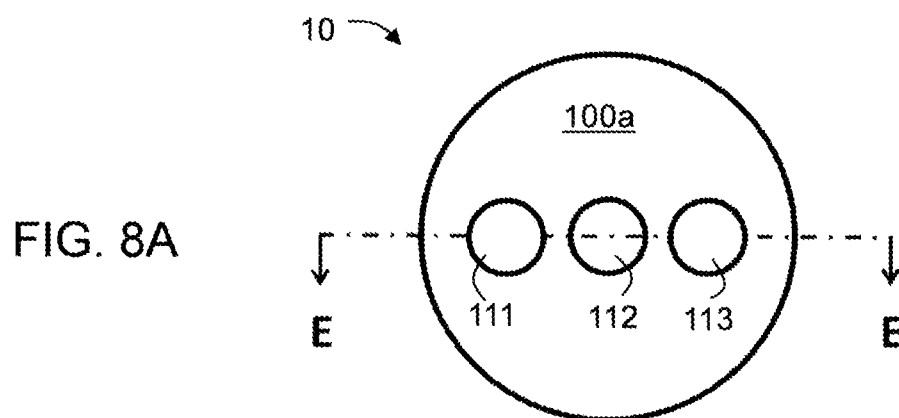


FIG. 9A

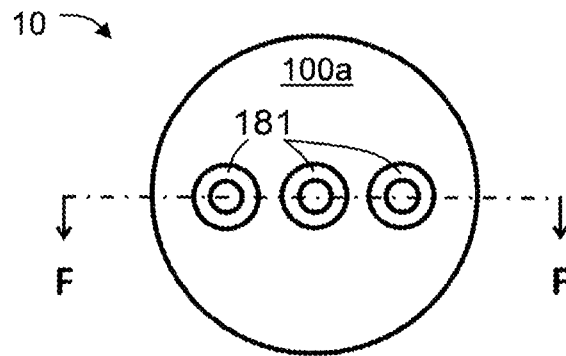
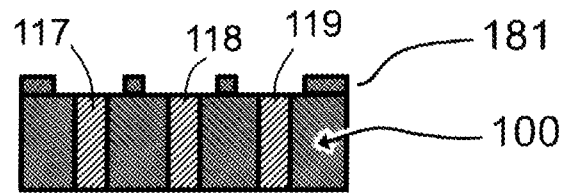


FIG. 9B



Section F-F

FIG. 10A

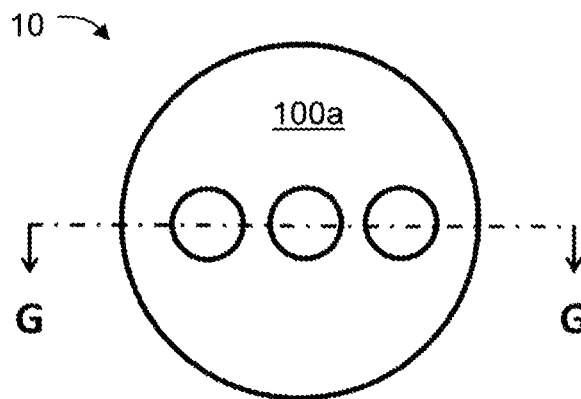
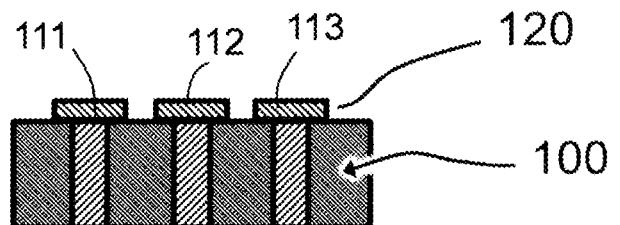


FIG. 10B



Section G-G

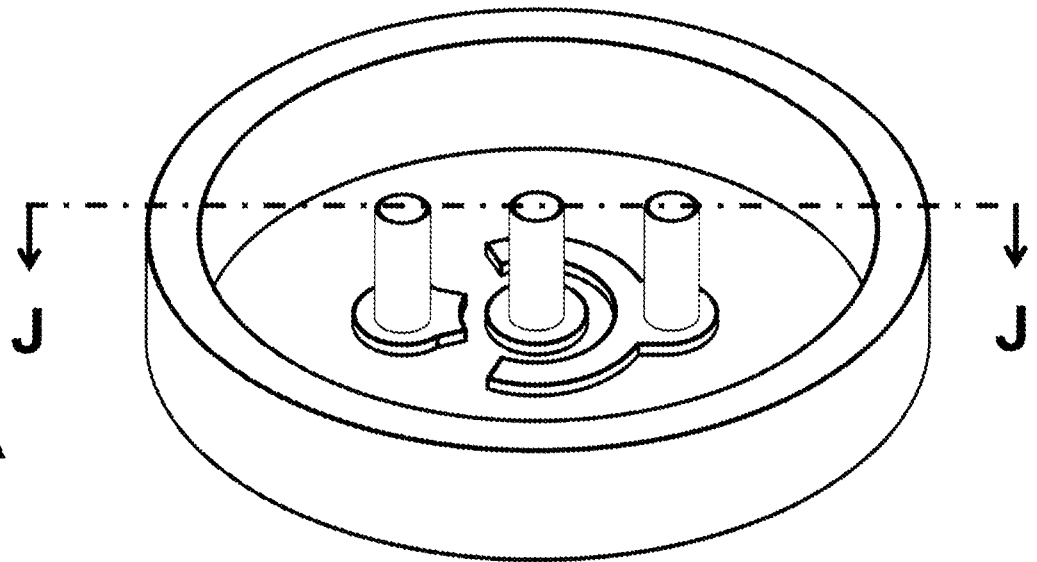


FIG. 11A

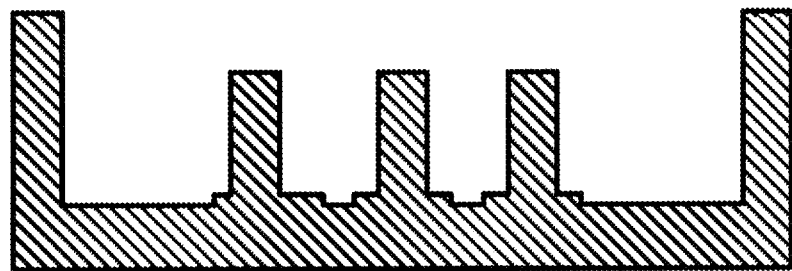


FIG. 11B

Section J-J

FIG. 11C

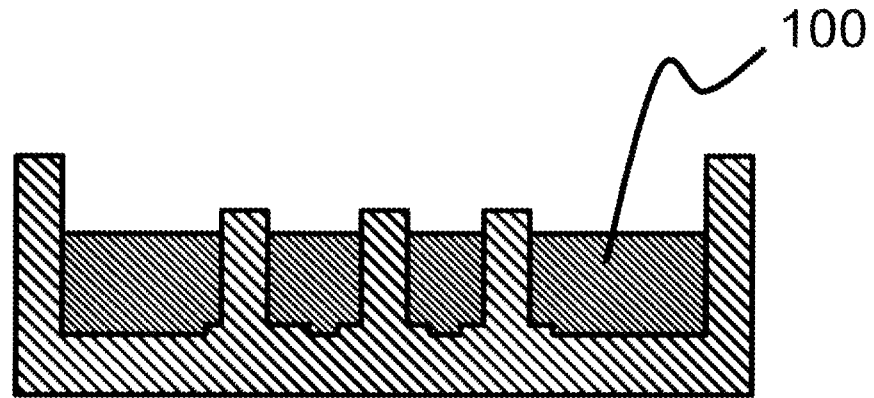


FIG. 11D

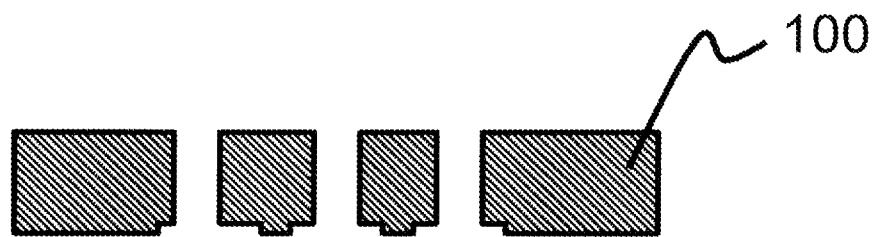
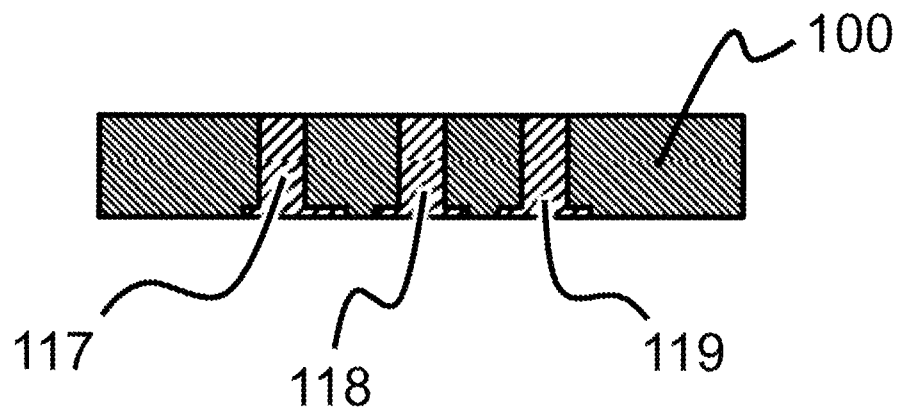


FIG. 11E



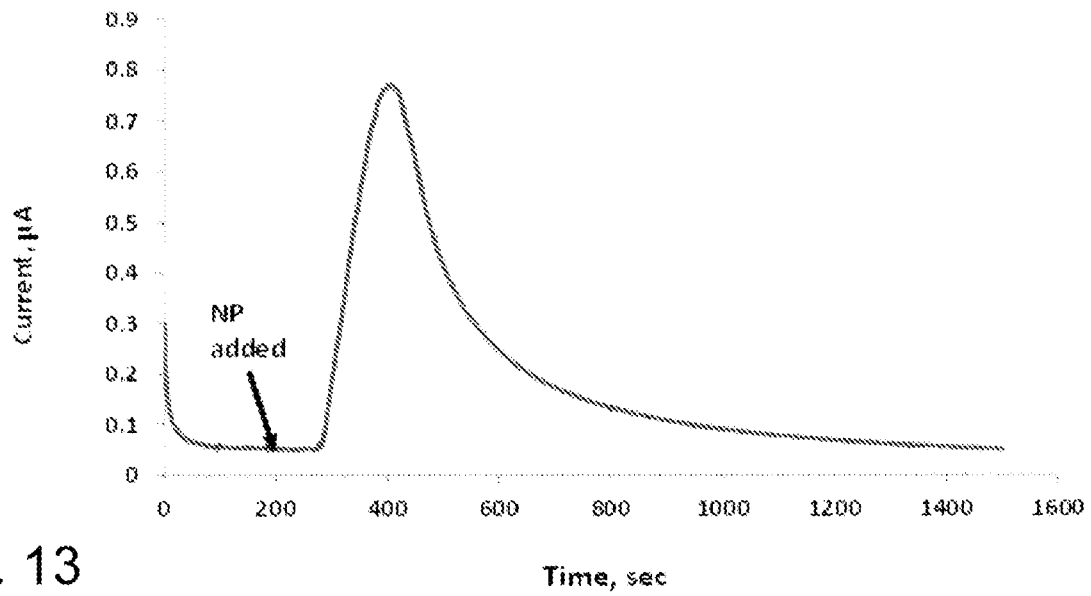


FIG. 13

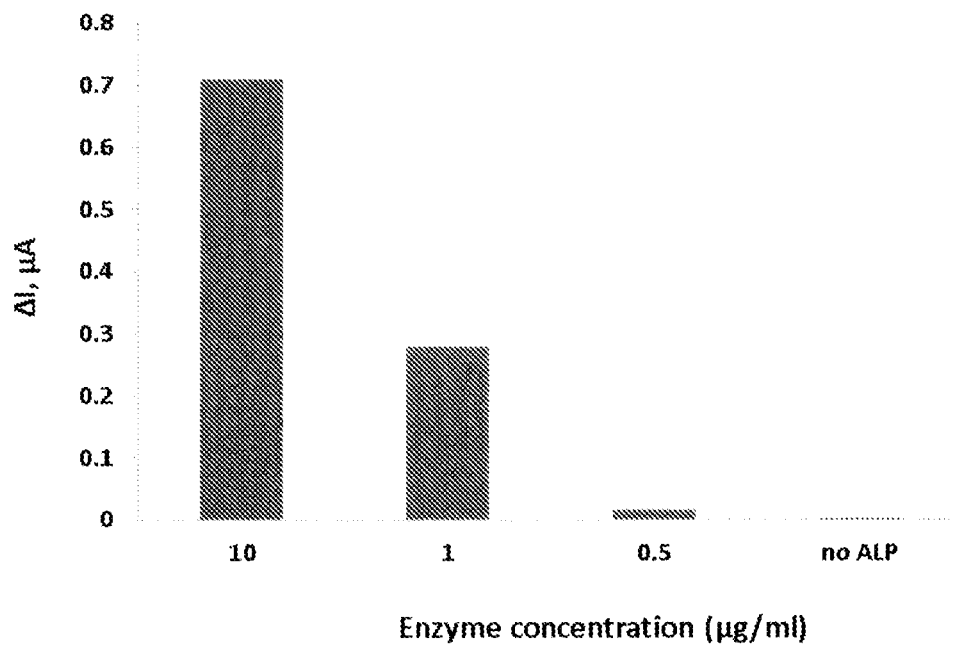


FIG. 14

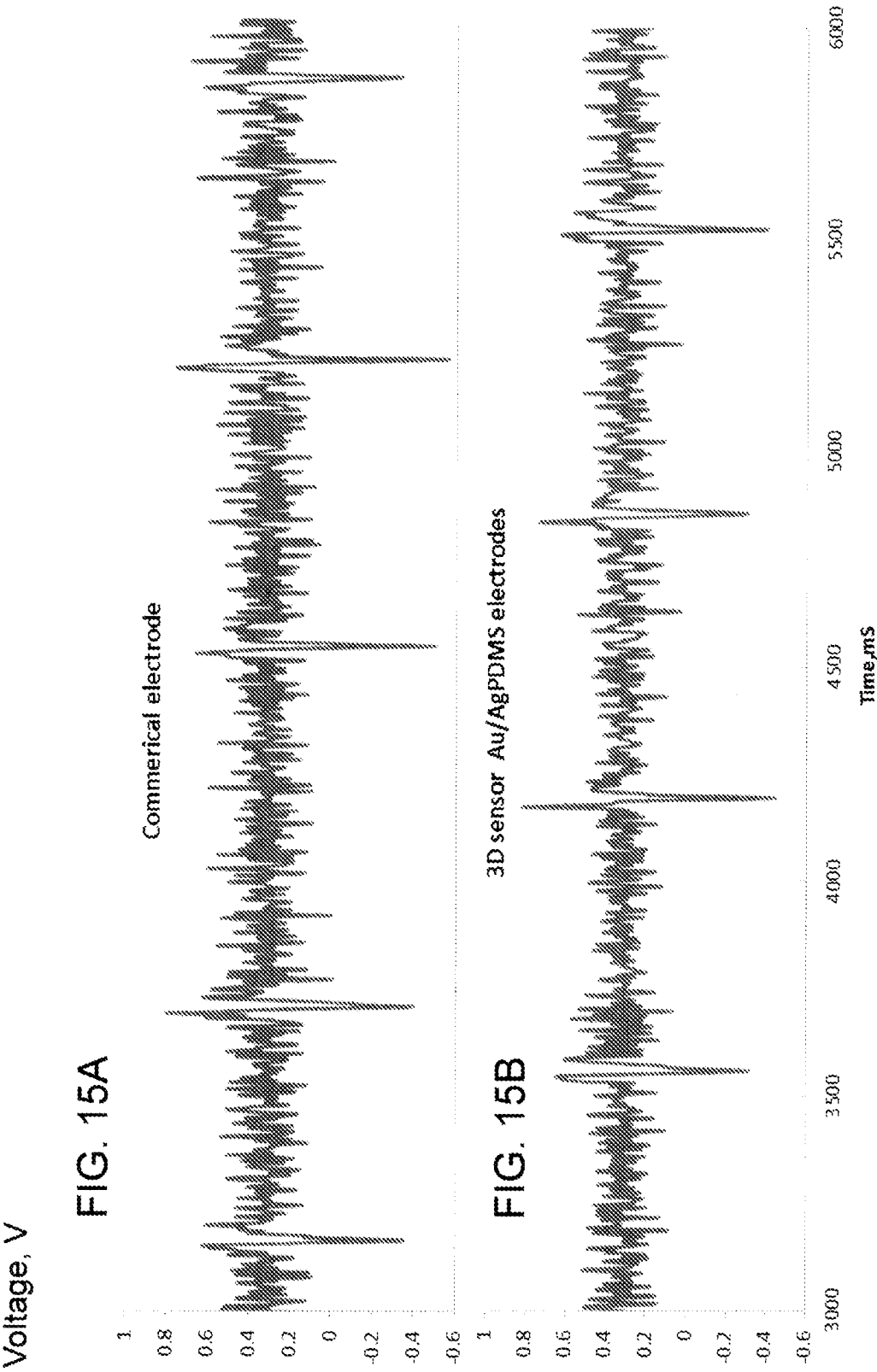


FIG. 16A

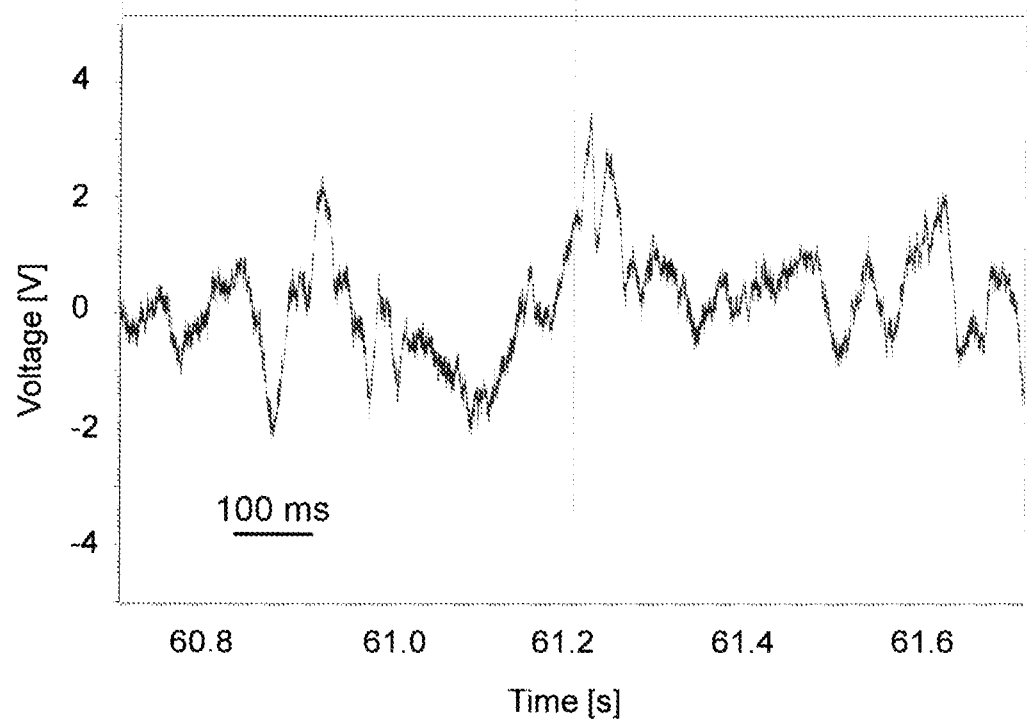


FIG. 16B

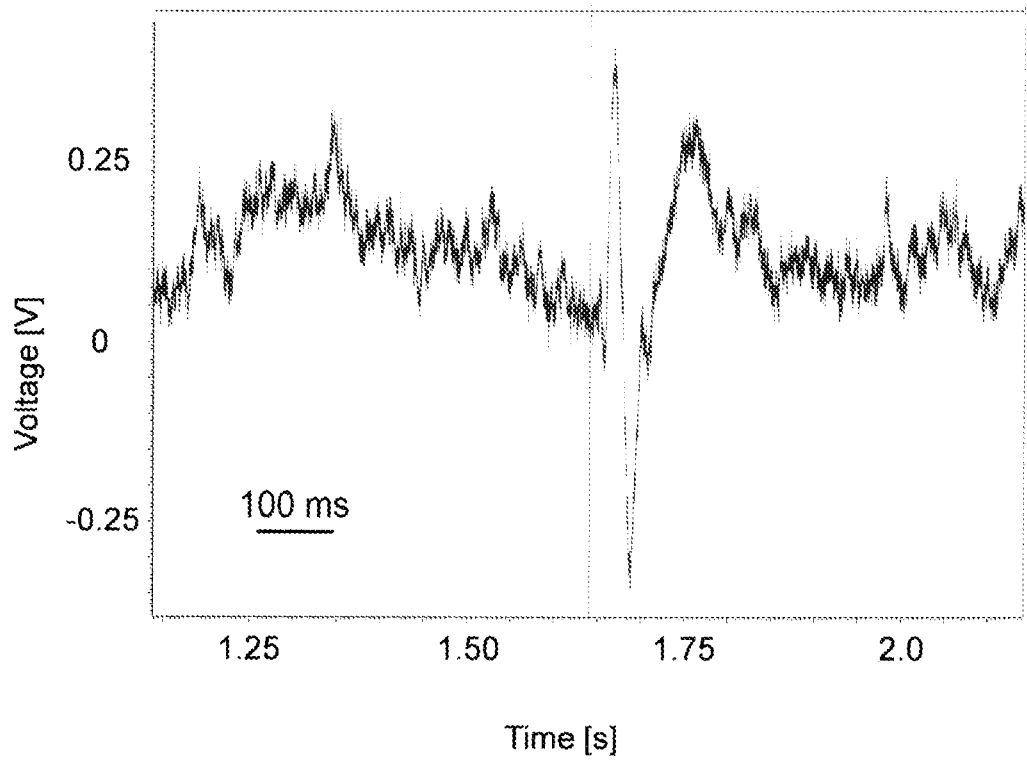


FIG. 16C

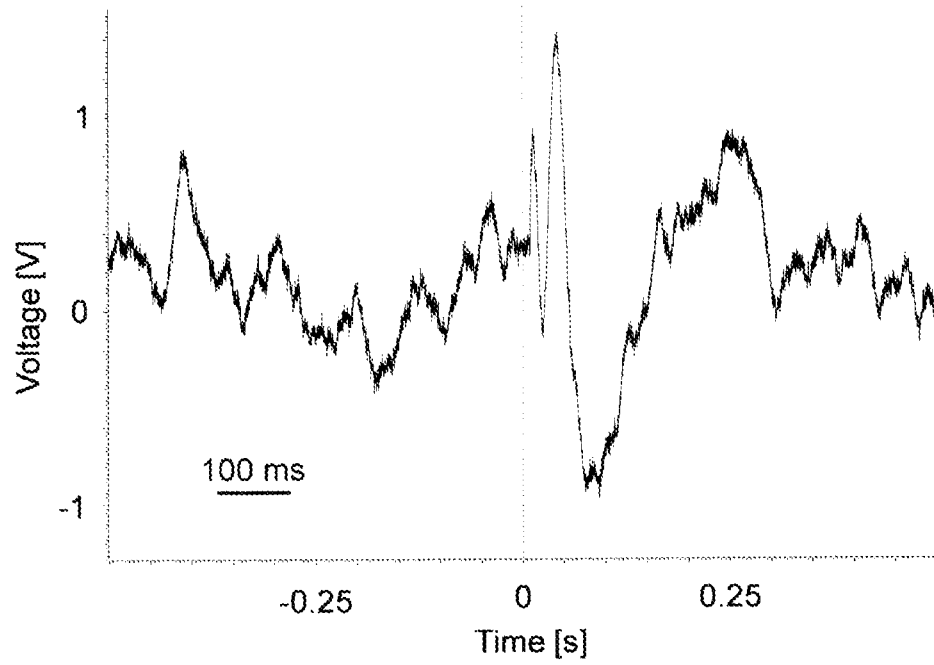


FIG. 16D

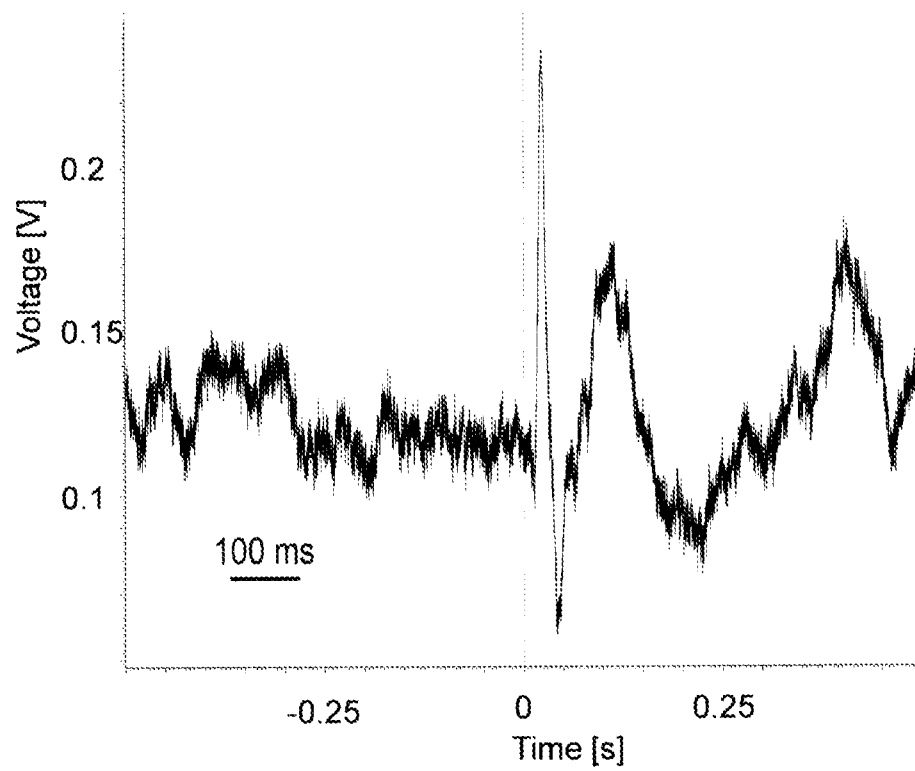


FIG. 16E

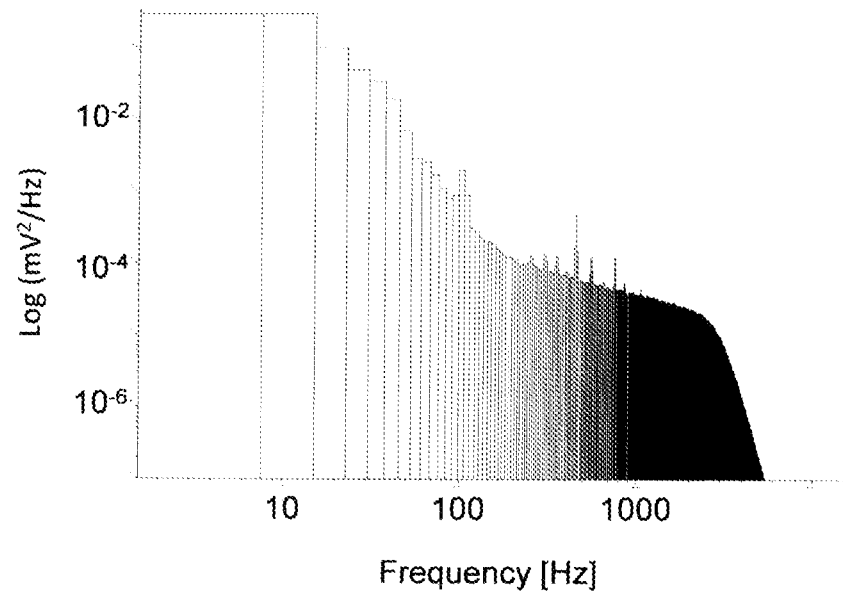
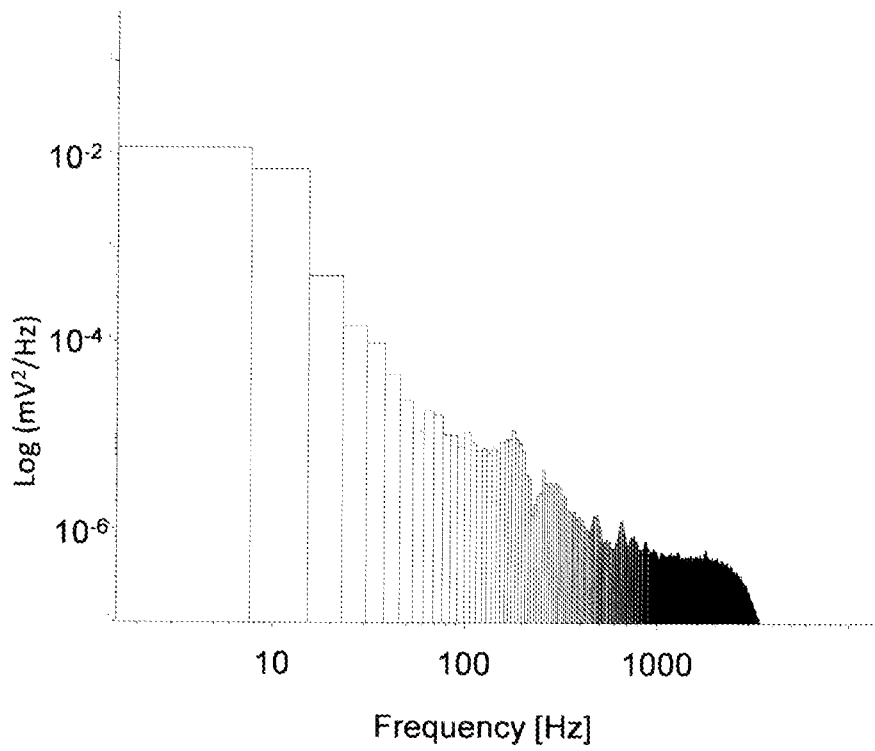


FIG. 16F



INTERNATIONAL SEARCH REPORT

International application No.

PCT/IL2013/050666

A. CLASSIFICATION OF SUBJECT MATTER IPC (2013.01) G01N 27/403, G01N 27/28, G01N 27/327, G01N 27/416, A61B 5/05, A61B 5/147300 According to International Patent Classification (IPC) or to both national classification and IPC		
B. FIELDS SEARCHED Minimum documentation searched (classification system followed by classification symbols) IPC (2013.01) G01N 27/00, A61B 5/00 Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched Electronic data base consulted during the international search (name of data base and, where practicable, search terms used) Databases consulted: Esp@cenet, Google Patents, Google Scholar, FamPat database Search terms used: SENSOR , ELECTROCHEMICAL , VIAS , SUBSTRATE		
C. DOCUMENTS CONSIDERED TO BE RELEVANT		
Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	US 7063776 B2 HUANG C.-M. 20 Jun 2006 (2006/06/20) Fig. 11,18 ; col. 4 lines 24-54 ; col. 5 line 44 –col. 6 line 7	1,2,5-7,10-12,15,16, 21,23-27,30
Y		3,8,9,17-20,22
X	US 2007138027 A1 DINSMOOR D. A. et al. 21 Jun 2007 (2007/06/21) Fig. 6 ; Paragraphs [0027], [0100]	1,2,4,6,11,12,15,16, 23-27,29,31
Y		3,8,9,17-20,22
X	US 7323142 B2 PENDO S. et al. 29 Jan 2008 (2008/01/29) Fig. 1,2 ,16 ; col. 4 lines 32-44 ; col. 5 lines 4-16 ; col. 5 lines 59-60	1,4,6,7,10-16,23-27, 29
Y		3,8,9,17-20,22
☒ Further documents are listed in the continuation of Box C. ☒ See patent family annex.		
* Special categories of cited documents: “A” document defining the general state of the art which is not considered to be of particular relevance “E” earlier application or patent but published on or after the international filing date “L” document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified) “O” document referring to an oral disclosure, use, exhibition or other means “P” document published prior to the international filing date but later than the priority date claimed “T” later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention “X” document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone “Y” document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art “&” document member of the same patent family		
Date of the actual completion of the international search 03 Nov 2013		Date of mailing of the international search report 25 Nov 2013
Name and mailing address of the ISA: Israel Patent Office Technology Park, Bldg.5, Malcha, Jerusalem, 9695101, Israel Facsimile No. 972-2-5651616		Authorized officer GUTMAN Ariel Telephone No. 972-2-5657816

INTERNATIONAL SEARCH REPORT

International application No.

PCT/IL2013/050666

C (Continuation). DOCUMENTS CONSIDERED TO BE RELEVANT		
Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	US 2011213229 A1 BENOIT V. 01 Sep 2011 (2011/09/01) Fig. 1&2; Paragraphs [0017]-[0018], [0024], [0208], [0209], [0213], [0219], [0316]-[0321]	1,2,4-7,10-12,15,16, 23-31
Y		3,8,9,17-20,22
X	US 2011203941 A1 SAY J. L. 25 Aug 2011 (2011/08/25) Fig. 1,2,6 ; paragraphs [0004], [0034],[0027],[0040]	1,2,4-7,10-12,15,16, 23-27,29-31
Y		3,8,9,18-20,22

INTERNATIONAL SEARCH REPORT
Information on patent family members

International application No.
PCT/IL2013/050666

Patent document cited search report			Publication date	Patent family member(s)		Publication Date	
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				EP	1634066	A1	15 Mar 2006
				EP	1634066	A4	22 Apr 2009
				JP	2006514300	A	27 Apr 2006
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				US	7063776	B2	20 Jun 2006
				US	2006196768	A1	07 Sep 2006
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				WO	2005005974	A1	20 Jan 2005
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US	7323142	B2	29 Jan 2008	AT	446667	T	15 Nov 2009
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				DK	1549242	T3	28 Oct 2013

INTERNATIONAL SEARCH REPORT

Information on patent family members

International application No.

PCT/IL2013/050666

Patent document cited search report	Publication date	Patent family member(s)	Publication Date
	EP 1436605	A1	14 Jul 2004
	EP 1436605	A4	04 Oct 2006
	EP 1436605	B1	21 Oct 2009
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	EP 1438029	A4	14 Jan 2009
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Information on patent family members

PCT/IL2013/050666

Form PCT/ISA/210 (patent family annex) (July 2009)

专利名称(译)	可放置的传感器及其使用方法		
公开(公告)号	EP2880432A1	公开(公告)日	2015-06-10
申请号	EP2013827917	申请日	2013-08-05
[标]申请(专利权)人(译)	特拉维夫大学拉莫特有限公司		
申请(专利权)人(译)	拉莫特AT特拉维夫大学LTD.		
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发明人	SHACHAM-DIAMAND, YOSI RAGONES, HEFTSI FREEMAN, AMIHAY SCHREIBER, DAVID		
IPC分类号	G01N27/403 G01N27/28 G01N27/416 A61B5/05 A61B5/1473		
CPC分类号	A61B5/1473 A61B1/3132 A61B5/00 A61B5/1477 A61B17/3423 G01N27/286 G01N27/327 Y10T29/49117		
优先权	61/679740 2012-08-05 US		
其他公开文献	EP2880432A4		
外部链接	Espacenet		

摘要(译)

公开了一种传感器系统。该系统包括：具有前侧和后侧的固体基板，形成在前侧并且被配置为提供电化学感测的感测组件，多个电触点，形成在后侧并且与后者电连通。传感组件通过多个互连件穿过基板并至少从前侧延伸到后侧，以及安装构件，其构造成将后侧安装到可移动装置的尖端上。